

FEATURES

- RMS on-state current to 0.8A
- General purpose switching



SOT-23

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
MCR100-6	SOT-23	100-6	3000
MCR100-8	SOT-23	100-8	3000



ELECTRICAL CHARACTERISTICS (Ta=25 unless otherwise specified)

Symbol	Parameter	Part	Value	Unit
V _{DRM}	Repetitive peak off-state voltage	MCR100-6	400	V
V _{RRM}	Repetitive peak reverse voltage	MCR100-8	600	V
V _{EBO}	Emitter-Base Voltage		7	V
I _{T(RMS)}	RMS on-state current(T=60℃)		0.8	А
I _{TSM}	Non repetitive surge peak on-state current(tp=10ms)		8	А
I _{GM}	Peak gate current (tp=20µs,Tj=110℃)		0.2	А
Р _{GM}	Peak gate power (tp=20µs,Tj=110℃)		500	mW
P _{G(AV)}	Average gate power dissipation(Tj=110 $^\circ \!\!\!\mathrm{C}$)		100	mW
TJ	Operation Junction Temperature Range		-40~+110	°C
T _{stg}	Storage Temperature Range		-40~+150	°C

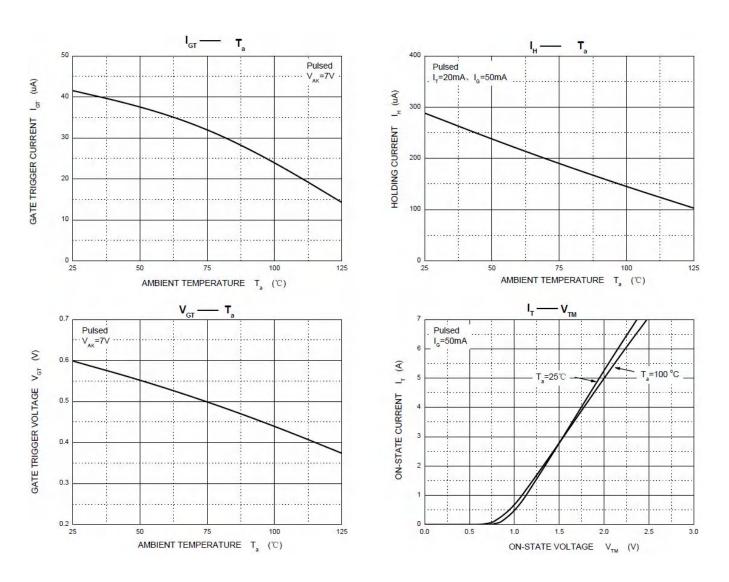


Electrical Characteristics (Ta=25°C unless otherwise specified)

Symbol	Parameter	Test conditions	Part	Min	Тур	Мах	Unit
V _{TM}	On state voltage	I _™ =1A ,tp=380µS				1.7	V
V _{GT}	Gate trigger voltage	V _{AK} =7V				0.8V	V
V	Peak Repetitive forward and	L /L _400A	MCR100-6	400			V
V _{(BR)EBO}	Reverse blocking voltage	I _{DRM} /I _{RRM} =100µA	MCR100-8	600			
I _{DRM}	Peak forward or reverse					10	μΑ
I _{RRM}	blocking Current	$V_{AK} = V_{DRM} \text{ or } V_{RRM}$				10	
Iн	Holding current	I _{HL} =20mA ,V _{AK} =7V				5	mA
I _{GT}	Gate trigger current	V _{AK} =7V		15		60	μA

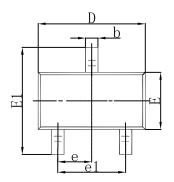
* Forward current applied for 1 ms maximum duration duty cycle1%.

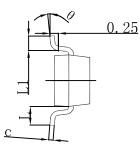
TypicalCharacteristics

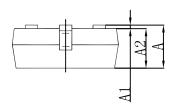




SOT-23 Package Outline Dimensions







Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.150	0.035	0.045	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.050	0.035	0.041	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
Е	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
e	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	8°	

SOT-23 Suggested Pad Layout



Note:

1.Controlling dimension: in millimeters.

2.General tolerance:± 0.05mm.

3. The pad layout is for reference purposes only.



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